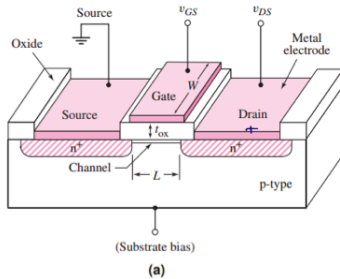


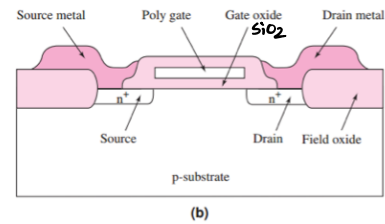
Lecture 15 : MOS Logic Families 1

MOSFET: Metal oxide semiconductor field effect Transistor.

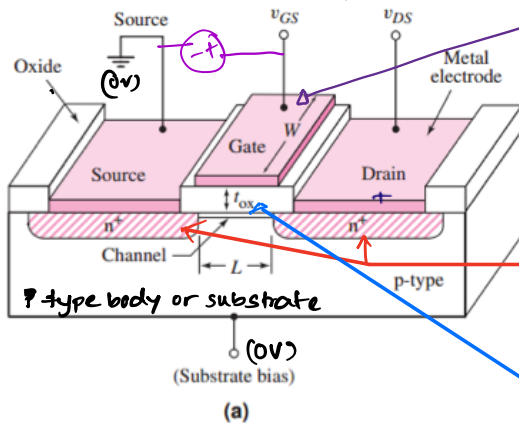
gate (input terminal) \rightarrow SiO_2 (Silicon di-oxide) \rightarrow body and source/drain \rightarrow Electric field causes current flow



MOSFET	BJT
N-type MOSFET	NPN-type BJT



Enhancement type MOSFET (NMOS):



③ A polysilicon gate was constructed on top of SiO_2 to ensure no current flow between gate and body

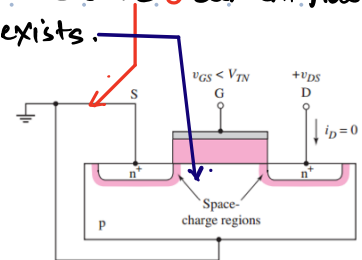
① In a P-type body, two n+ diffusion (n-type) are constructed. Hence 2 P-n junctions get created.
 • These n+ diffusions are called source and Drain terminal. Since MOSFET is symmetrical, these two terminals can be interchanged.

② Over the n+ diffusion, there was a thin layer of dielectric or insulator (SiO_2) with thickness t_{ox} .

4. Body and Source is connected to the same potential to ensure 0 current flow.

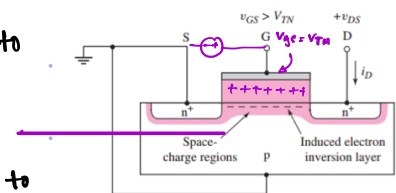
5. In an enhancement type MOSFET, initially no channel exists.

6. Need to create a channel to ensure current flow or conduction, an external electric field/voltage is applied between gate and Source, V_{gs} .



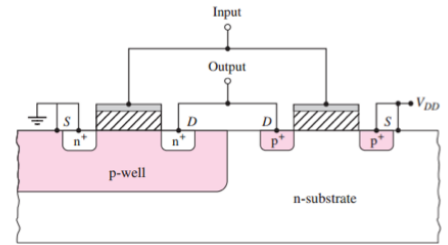
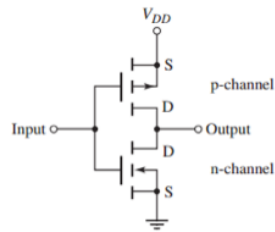
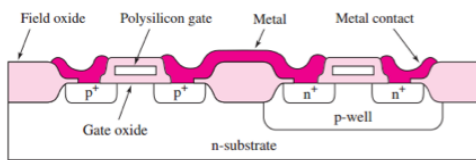
7. This V_{gs} is quite weak to attract the minority carrier or e^- in a p-type body. When $V_{gs} = V_{th}$ (here, V_{th} or V_{th} (threshold voltage) is actually the applied V_{gs}) the applied voltage is strong enough to attract e^- towards gate. Due to SiO_2 , these free e^- cannot recombine with +ve charge in gate and stored underneath the SiO_2 . The stored e^- creates a bridge between both n+ diffusion (source & Drain) and equal to the gate (+ve) charge. So, at $V_{gs} = V_{th}$ mosfet turns ON.

8. To create current flow between Drain & Source, another electric field/voltage is applied between Drain and source. V_{ds} .

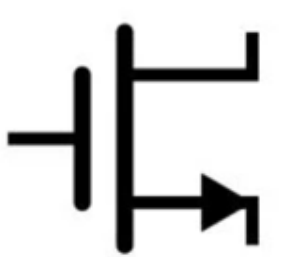
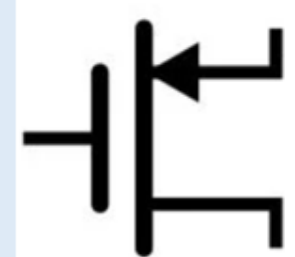


Lecture 18 : CMOS Logic Families 2

CMOS Structure



Summary:

	NMOS	PMOS
High Voltage at Gate	ON	OFF
Low Voltage at Gate	OFF	ON
Symbol	 Outward arrow	 Inward arrow

Logic circuits using CMOS

Rule 1: If the gate voltage is high/low then NMOS will turn ON/OFF and PMOS will turn OFF/ON. If any MOSFET turns on then drain and source terminal would be short circuited.

Rule 2: Conduction complement: We will design "pull-up network" using PMOS as the conduction complement of "pull-down network" using CMOS.

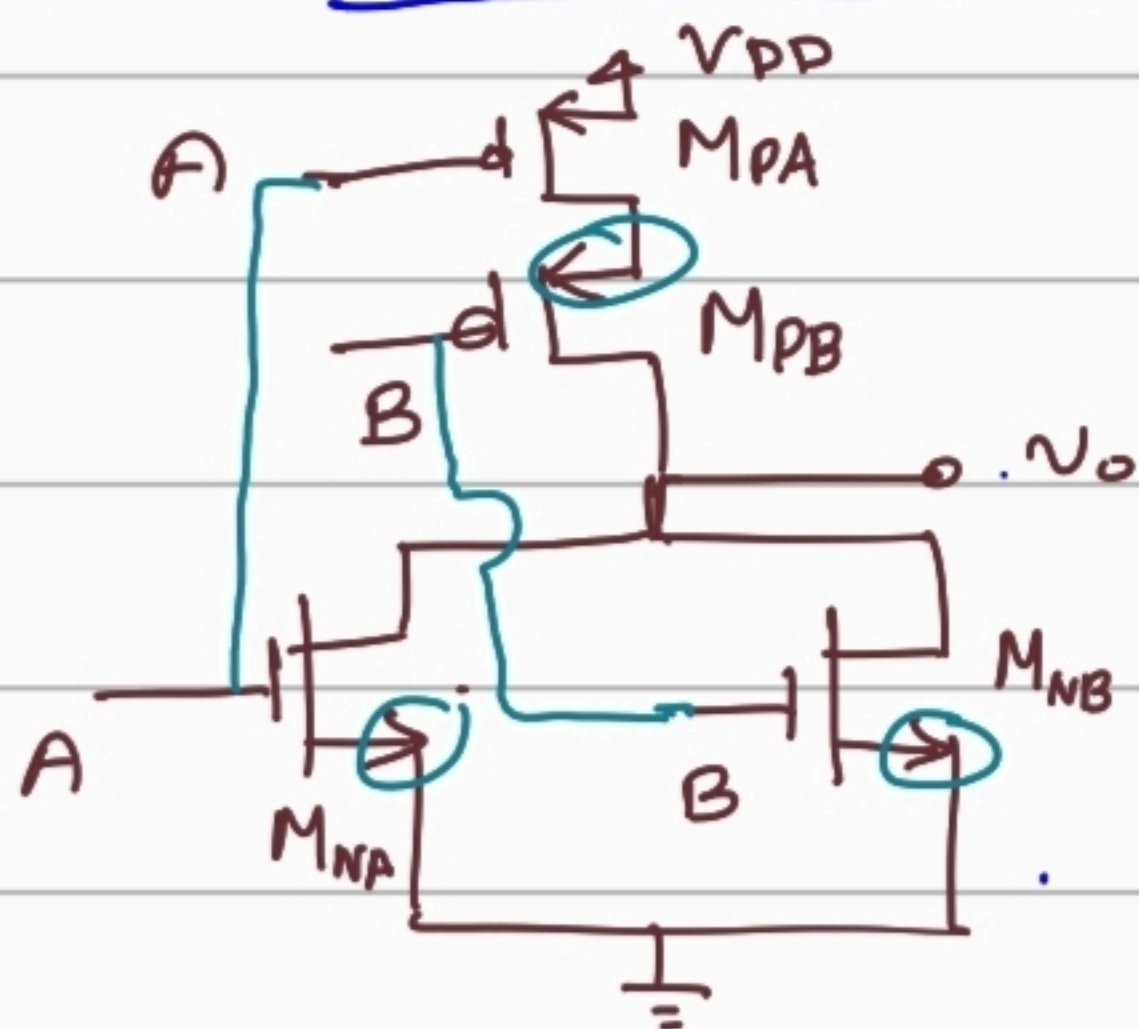
□ Conduction complement means if NMOS are in series/parallel connection then PMOS are going to be in parallel/series.

□ Pull-up network rises the output level to the logical high voltage.

□ Pull-down networks declines the output level to the logical low voltage.

Example 1: CMOS NOR GATE:

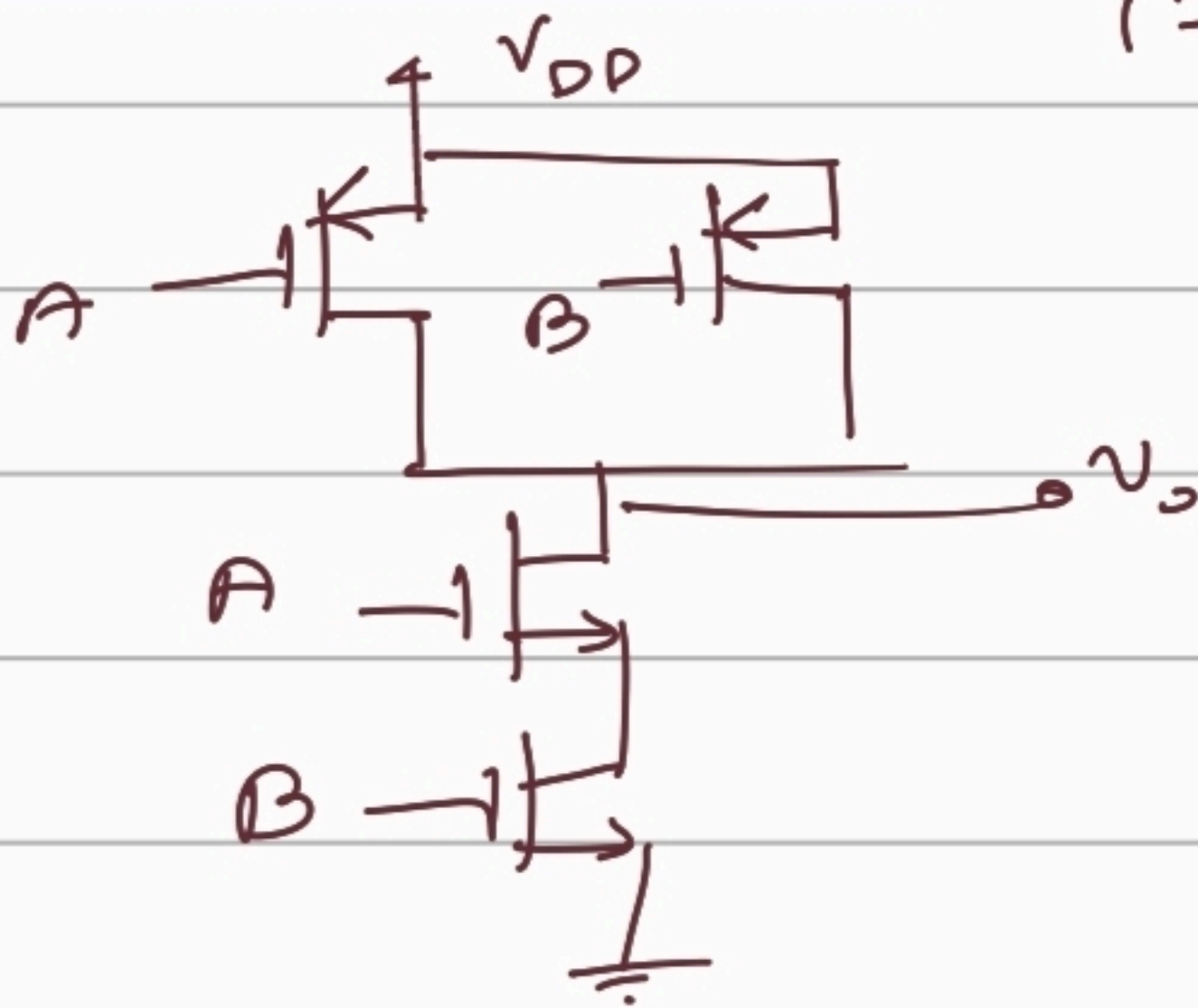
$$Y = \overline{A + B}$$



A	B	M _{PA}	M _{PB}	M _{NA}	M _{NB}	V _O
0	0	ON	ON	OFF	OFF	V _{DD}
0	V _{DD}	ON	OFF	OFF	ON	0
V _{DD}	0	OFF	ON	OFF	ON	0
V _{DD}	V _{DD}	OFF	OFF	ON	ON	0

CMOS NAND GATE

$$Y = \overline{AB}$$

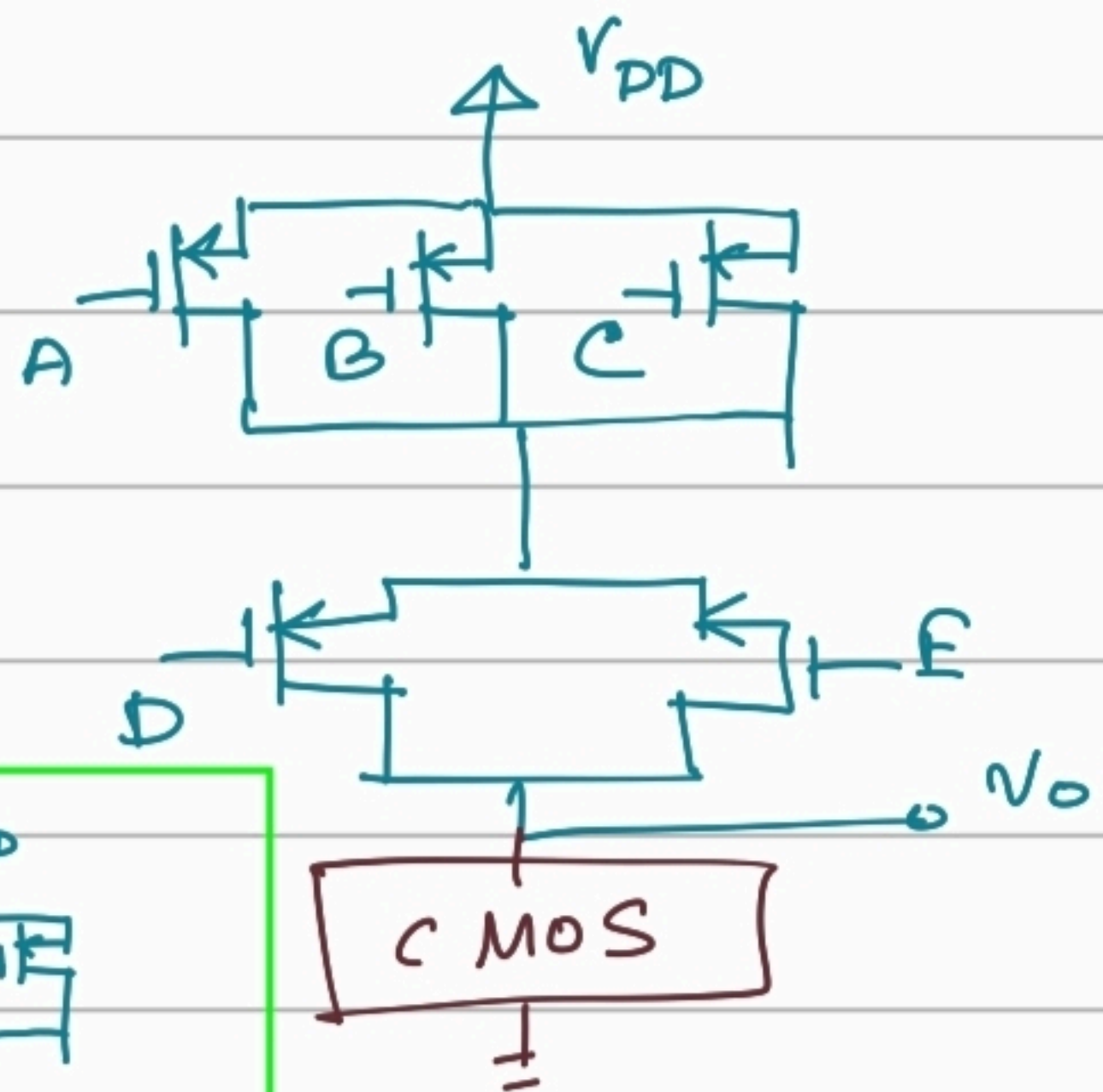
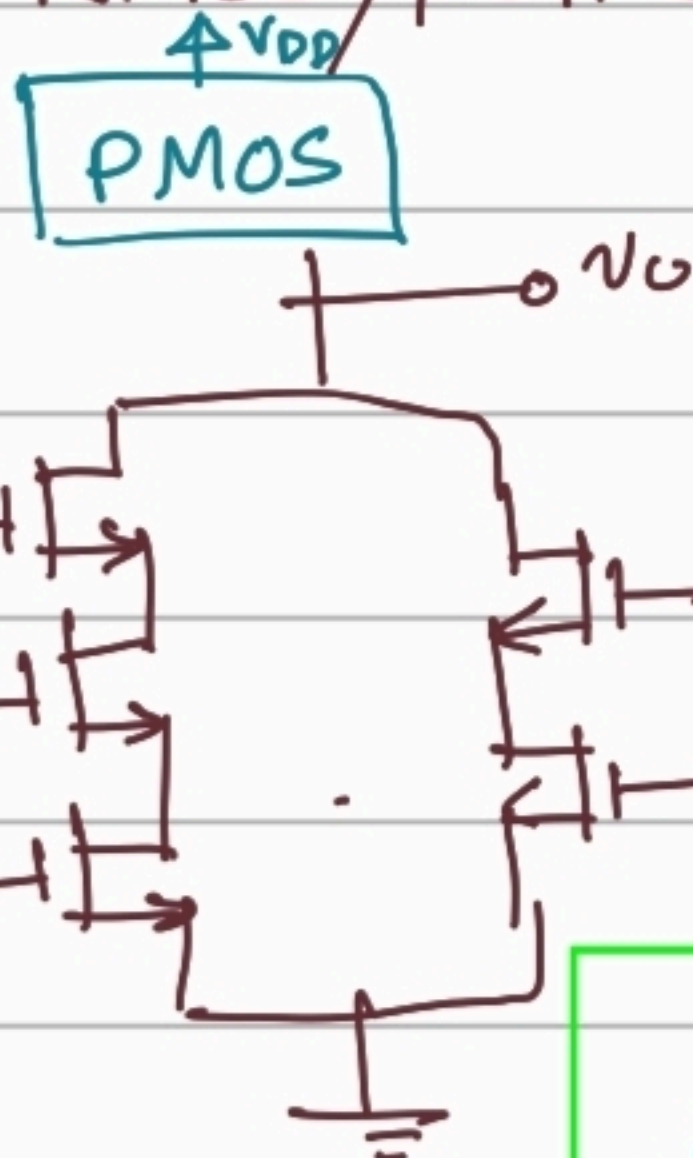


You can easily verify this works like a NAND gate.

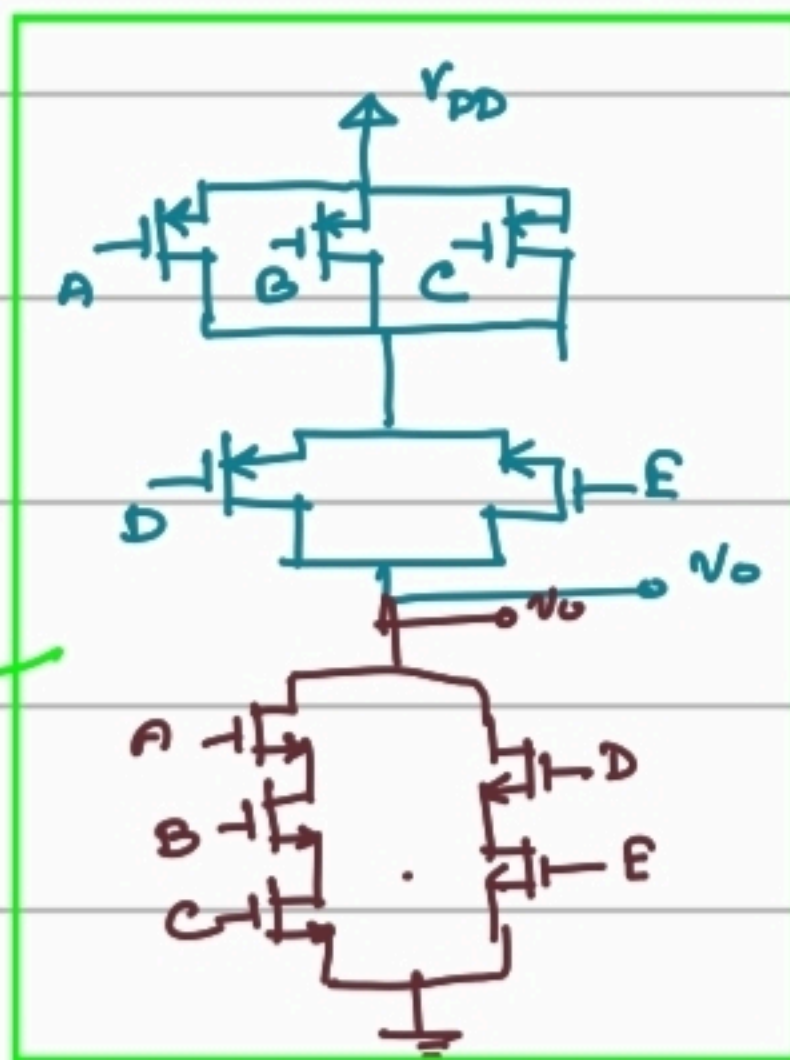
#Rule 3: In order to design pull-down network we must use series NMOS connection for AND logic and parallel NMOS connection for OR logic under the whole inverse sign.)

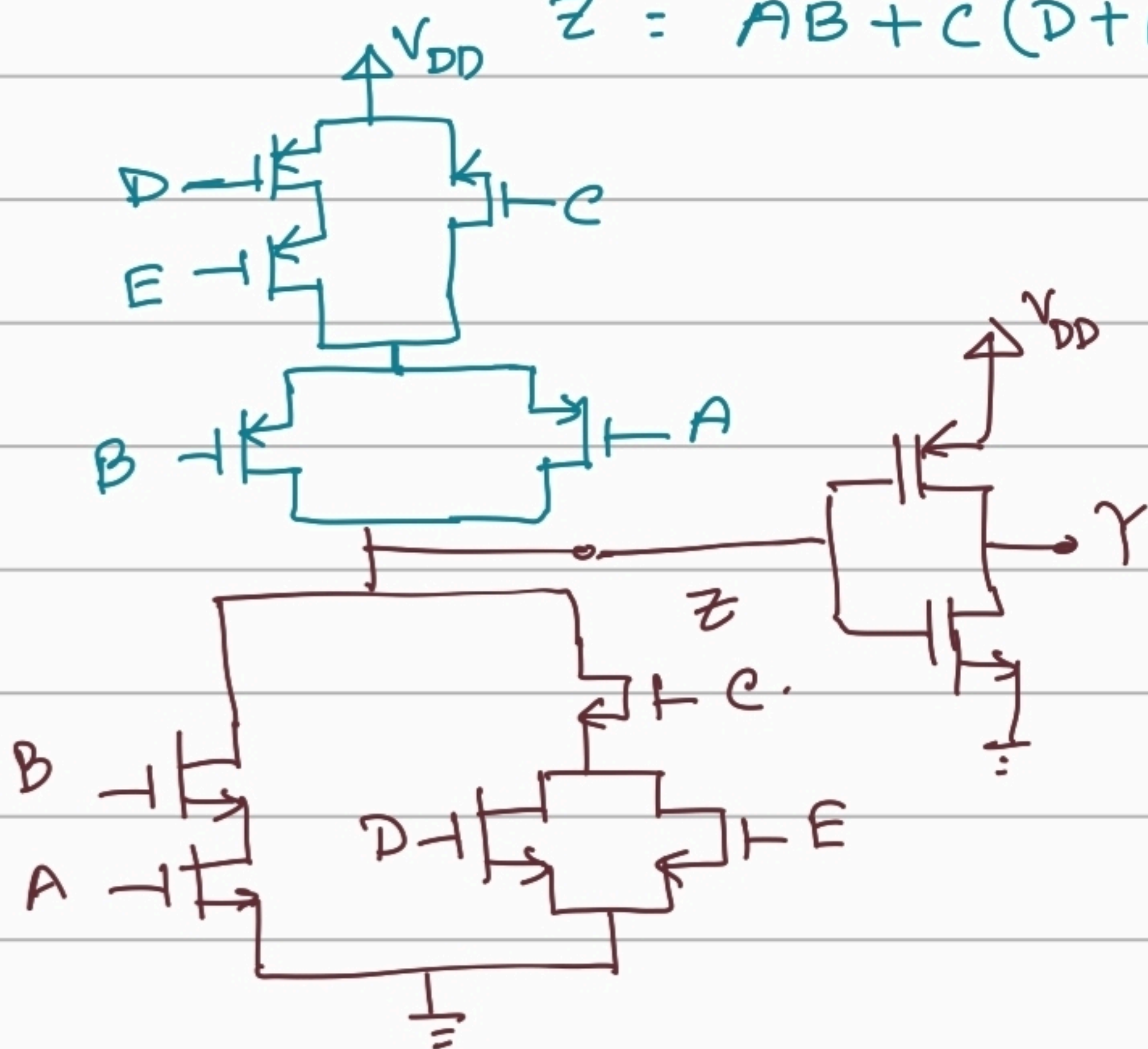
Example: $Y = \overline{ABC + DE}$

Solⁿ: NMOS/pull down network:



Total circuit.



$$Z = \overline{AB + C(D + E)}$$


Switching up series connections doesn't change output.

April - 16, Quiz 4. Question has been announced.

"NMOS NOR gate with DEPLETION LOAD"

Lecture 16: ADC and DAC.

Physical world's informations are analog
Analog means data could take any real value at each instant of time.

In order to store/process we use digital data in our computers and microprocessor. Digital data means binary bit of strings.

Environment \rightarrow Transducer $\xrightarrow{\text{A/D}}$ Computer $\xrightarrow{\text{D/A}}$ speaker